

CLAIMS

1. An electronic component packaging container which uses a multilayer polyester sheet comprising a base layer containing a polyethylene terephthalate type resin and a polycarbonate type resin and a surface layer containing a polycarbonate type resin, formed on at least one side of the base layer, wherein the base layer contains from 70 to 97 wt% of the polyethylene terephthalate type resin and from 3 to 30 wt% of the polycarbonate type resin based on the total amount of the polyethylene terephthalate type resin and the polycarbonate type resin, and the thickness of the surface layer is from 10 to 30% of the total thickness.
2. The electronic component packaging container according to Claim 1, wherein the multilayer polyester sheet has a total light transmittance of at least 85% and a cloudiness of at most 10%.
3. The electronic component packaging container according to Claim 1 or 2, which has an antistatic treatment applied to one or both sides.
4. A sheet which comprises a base layer containing a polyethylene terephthalate type resin and a polycarbonate type resin, a surface layer containing a polycarbonate type resin formed on at least one side of the base layer, and a coating layer of an electrically conductive coating formed on at least one side of the surface layer, wherein the base layer contains from 70 to 97 wt% of the

Sub A1

polyethylene terephthalate type resin and from 3 to 30 wt% of the polycarbonate type resin based on the total amount of the polyethylene terephthalate type resin and the polycarbonate type resin, the thickness of the 5 surface layer is from 10 to 30% of the total thickness, and the coating layer has a surface specific resistance within a range of from 10^4 to 10^{14} Ω .

5. The sheet according to Claim 4, wherein the electrically conductive coating contains carbon black
10 and/or an antistatic agent.

6. The sheet according to Claim 5, wherein the antistatic agent is a high polymer antistatic agent.

7. An electronic component packaging container which comprises the sheet as defined in any one of Claims 4 to
15 6.

8. The electronic component packaging container according to any one of Claims 1, 2, 3 and 7, which is a carrier tape.

9. A packaged product of an electronic component,
20 wherein the electronic component is stored in the carrier tape as defined in Claim 8 and heat-sealed with a cover tape.

Add A3